

CAMP TUITION SCHOLARSHIP APPLICATION

UNIVERSITY OF DAYTON SUMMER HONORS ENGINEERING CAMP 2015

JUNE 14-19, 2015 JUNE 21-26, 2015 (choose one)

Scholarships are awarded according to the following guidelines in order of consideration:

1. Demonstrated academic performance in mathematics and science – **high school transcript must be submitted by your high school guidance counselor.**
2. Desire to participate – personal statement (1-3 paragraphs) on why you want to attend camp – see below and/or attach separate sheet of paper.
3. Recommendation of teacher or counselor.
4. Number of requests for scholarships.
5. Need for assistance – income eligibility guidelines for the free and reduced price meals program.

Both a parent or guardian and a school guidance counselor must sign the scholarship application form. ALL REQUESTED INFORMATION IS REQUIRED. Incomplete scholarship applications will not be considered.

The application, **with high school transcript**, should be placed in a sealed envelope and sent by your guidance counselor to University of Dayton, Summer Honors Engineering Camp, 300 College Park, Dayton, OH 45469-0227.

Scholarship applications **must be received by April 15, 2015**. The number of scholarships available is determined by the amount we receive in tuition and the amount of funds we receive from companies and industries that support our program.

CAMPER INFORMATION

Name _____

Name you prefer to be called _____

Address _____

City/State/ZIP _____

Phone number _____ Parent email _____

Birth date _____ Current grade level _____

(9th, 10th or 11th)

School name _____ Type of school: Rural Urban Suburban

Ethnic background: African-American Asian-American Caucasian
 Hispanic Native American Other/Unspecified

Gender: Female Male

How did you find out about our program? _____

Parent/Guardian name _____

Emergency phone number _____

Student's signature _____

I am requesting: UD employee discount; employee name and department _____
(camper must be son or daughter of UD employee)

Maximum camp tuition scholarship (\$600) Partial camp tuition scholarship (\$350)

I give my permission for the school to provide the information below regarding my child.

Parent/Guardian's signature _____

Please explain your desire to participate in the Summer Honors Engineering Camp at UD (you may attach a separate sheet of paper for this question) _____

SCHOOL INFORMATION

(TO BE COMPLETED BY SCHOOL GUIDANCE COUNSELOR)

Counselor name _____ Phone _____

Student's GPA _____

- Student qualifies for reduced lunches.
- Student qualifies for free lunches.
- Student does not qualify for reduced or free lunches, but assistance is needed for student to attend the summer camp.
- Student does not require financial assistance.

The applicant's commitment to her education is:

- Excellent Good Fair Poor

I recommend this applicant:

- Very enthusiastically Enthusiastically Moderately Not at all

Counselor Signature

Email Address

Comments _____

Please mail completed application in a sealed envelope, with a copy of the student's high school transcript, to:

Beth Hart
University of Dayton
Summers Honors Engineering Camp
300 College Park
Dayton, Ohio 45469-0227
Fax: 937-229-2756
ehart1@udayton.edu

Have questions?
Contact Beth Hart at ehart1@udayton.edu or 937-229-5080.

